Application Number	Re		Reexaminat MATSUKA	pplicant(s)/Patent under eexamination ATSUKAWA ET AL.	
Document Code - DISQ		ocument	cument – DO NOT MAIL		
TERMINAL DISCLAIMER	APPROVED			☐ DISAPPROVED	
Date Filed : 9-12-06	This patent to a Te Discl	t			
Approved/Disapproved b	y: Debi	sie			

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